

preliminary

Sonic Fast Recovery Diode

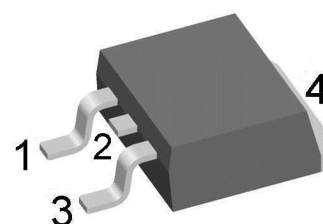
V_{RRM}	=	600 V
I_{FAV}	=	30 A
t_{rr}	=	35 ns

High Performance Fast Recovery Diode
 Low Loss and Soft Recovery
 Single Diode

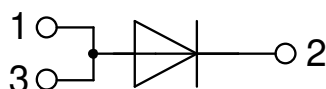
Part number

DHG30IM600PC

Marking on Product: DHG30IM600PC



Backside: cathode



Features / Advantages:

- Planar passivated chips
- Very low leakage current
- Very short recovery time
- Improved thermal behaviour
- Very low I_{rm} -values
- Very soft recovery behaviour
- Avalanche voltage rated for reliable operation
- Soft reverse recovery for low EMI/RFI
- Low I_{rm} reduces:
 - Power dissipation within the diode
 - Turn-on loss in the commutating switch

Applications:

- Antiparallel diode for high frequency switching devices
- Antisaturation diode
- Snubber diode
- Free wheeling diode
- Rectifiers in switch mode power supplies (SMPS)
- Uninterruptible power supplies (UPS)

Package: TO-263 (D2Pak)

- Industry standard outline
- RoHS compliant
- Epoxy meets UL 94V-0

Disclaimer Notice

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Fast Diode				Ratings			
Symbol	Definition	Conditions		min.	typ.	max.	Unit
V _{RSM}	max. non-repetitive reverse blocking voltage	T _{VJ} = 25°C				600	V
V _{RRM}	max. repetitive reverse blocking voltage	T _{VJ} = 25°C				600	V
I _R	reverse current, drain current	V _R = 600 V	T _{VJ} = 25°C			50	μA
		V _R = 600 V	T _{VJ} = 125°C			4	mA
V _F	forward voltage drop	I _F = 30 A	T _{VJ} = 25°C			2.26	V
		I _F = 60 A				3.11	V
		I _F = 30 A	T _{VJ} = 125°C			2.22	V
		I _F = 60 A				3.20	V
I _{FAV}	average forward current	T _C = 95°C rectangular d = 0.5	T _{VJ} = 150°C			30	A
V _{F0}	threshold voltage	} for power loss calculation only		T _{VJ} = 150°C		1.17	V
r _F	slope resistance					32	mΩ
R _{thJC}	thermal resistance junction to case					0.6	K/W
R _{thCH}	thermal resistance case to heatsink				0.25		K/W
P _{tot}	total power dissipation	T _C = 25°C				210	W
I _{FSM}	max. forward surge current	t = 10 ms; (50 Hz), sine; V _R = 0 V		T _{VJ} = 45°C		200	A
C _J	junction capacitance	V _R = 400 V f = 1 MHz		T _{VJ} = 25°C	16		pF
I _{RM}	max. reverse recovery current	} I _F = 35 A; V _R = 400 V -di _F /dt = 600 A/μs		T _{VJ} = 25 °C	12		A
				T _{VJ} = °C	tbd		A
t _{rr}	reverse recovery time			T _{VJ} = 25 °C	35		ns
				T _{VJ} = °C	tbd		ns

Package TO-263 (D2Pak)				Ratings			
Symbol	Definition	Conditions	min.	typ.	max.	Unit	
I_{RMS}	RMS current	per terminal ¹⁾			35	A	
T_{VJ}	virtual junction temperature		-55		150	°C	
T_{op}	operation temperature		-55		125	°C	
T_{stg}	storage temperature		-55		150	°C	
Weight	Product Marking	Part description		2		g	
F_C	mounting force with clip		20		60	N	

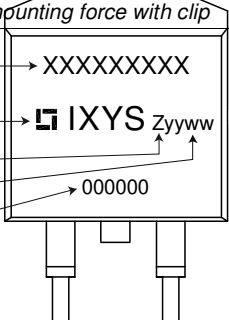
¹⁾ I_{VJ} Part No. → XXXXXXXXX

Logo → IXYS

Assembly Line → Zyyyww

Date Code → 000000

Assembly Code →



D = Diode

H = Sonic Fast Recovery Diode

30 = Current Rating [A]

IM = Single Diode

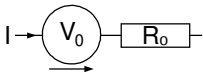
600 = Reverse Voltage [V]

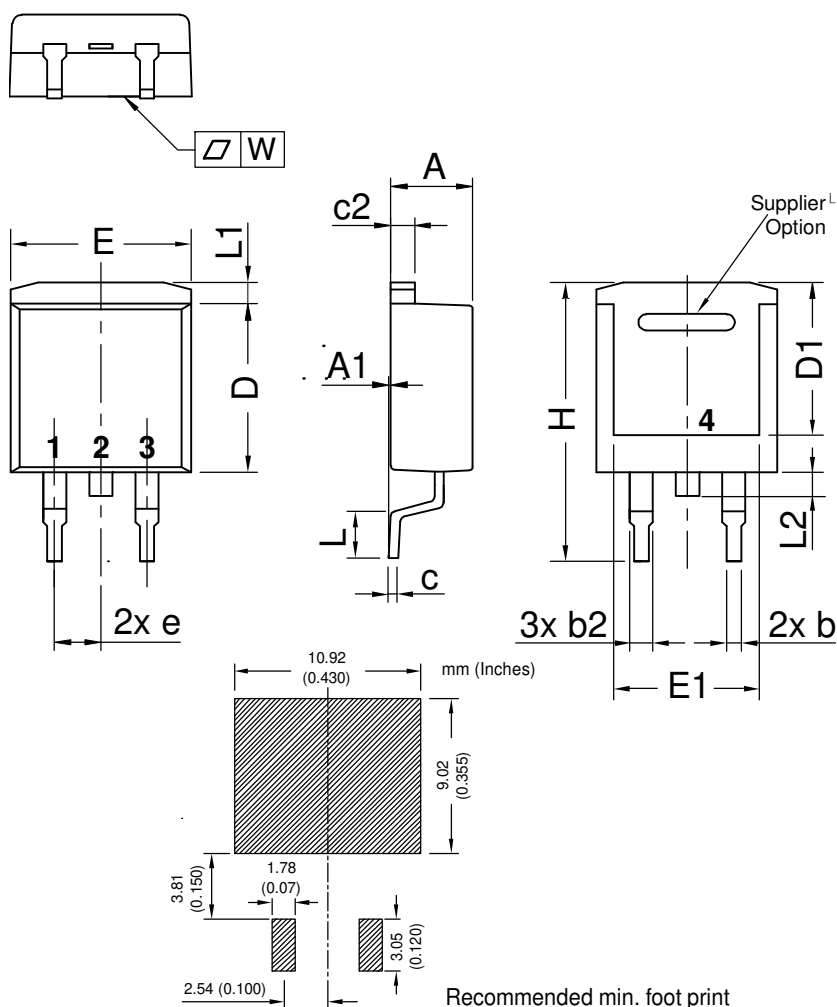
PC = TO-263AB (D2Pak) (2)

if the chip (2). In case of (1) and a pin connecting the pins as one contact.

Ordering	Ordering Number	Marking on Product	Delivery Mode	Quantity	Code No.
Standard	DHG30IM600PC-TRL	DHG30IM600PC	Tape & Reel	800	503501
Alternative	DHG30IM600PC-TUB	DHG30IM600PC	Tube	50	525078

Similar Part	Package	Voltage class
DHG30I600PA	TO-220AC (2)	600
DHG30I600HA	TO-247AD (2)	600

Equivalent Circuits for Simulation			$T_{VJ} = 150^{\circ}\text{C}$
			
$V_{0\max}$	threshold voltage	1.17	V
$R_{0\max}$	slope resistance *	29	mΩ

Outlines TO-263 (D2Pak)


Dim.	Millimeter		Inches	
	min	max	min	max
A	4.06	4.83	0.160	0.190
A1	typ. 0.10		typ. 0.004	
A2	2.41		0.095	
b	0.51	0.99	0.020	0.039
b2	1.14	1.40	0.045	0.055
c	0.40	0.74	0.016	0.029
c2	1.14	1.40	0.045	0.055
D	8.38	9.40	0.330	0.370
D1	8.00	8.89	0.315	0.350
D2	2.5		0.098	
E	9.65	10.41	0.380	0.410
E1	6.22	8.50	0.245	0.335
e	2.54 BSC		0.100 BSC	
e1	4.28		0.169	
H	14.61	15.88	0.575	0.625
L	1.78	2.79	0.070	0.110
L1	1.02	1.68	0.040	0.066
W	typ. 0.02	0.040	typ. 0.0008	0.002

All dimensions conform with and/or within JEDEC standard.

